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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	384
Number of Logic Elements/Cells	-
Total RAM Bits	442368
Number of I/O	200
Number of Gates	250000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	456-BBGA
Supplier Device Package	456-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v250-5fg456i

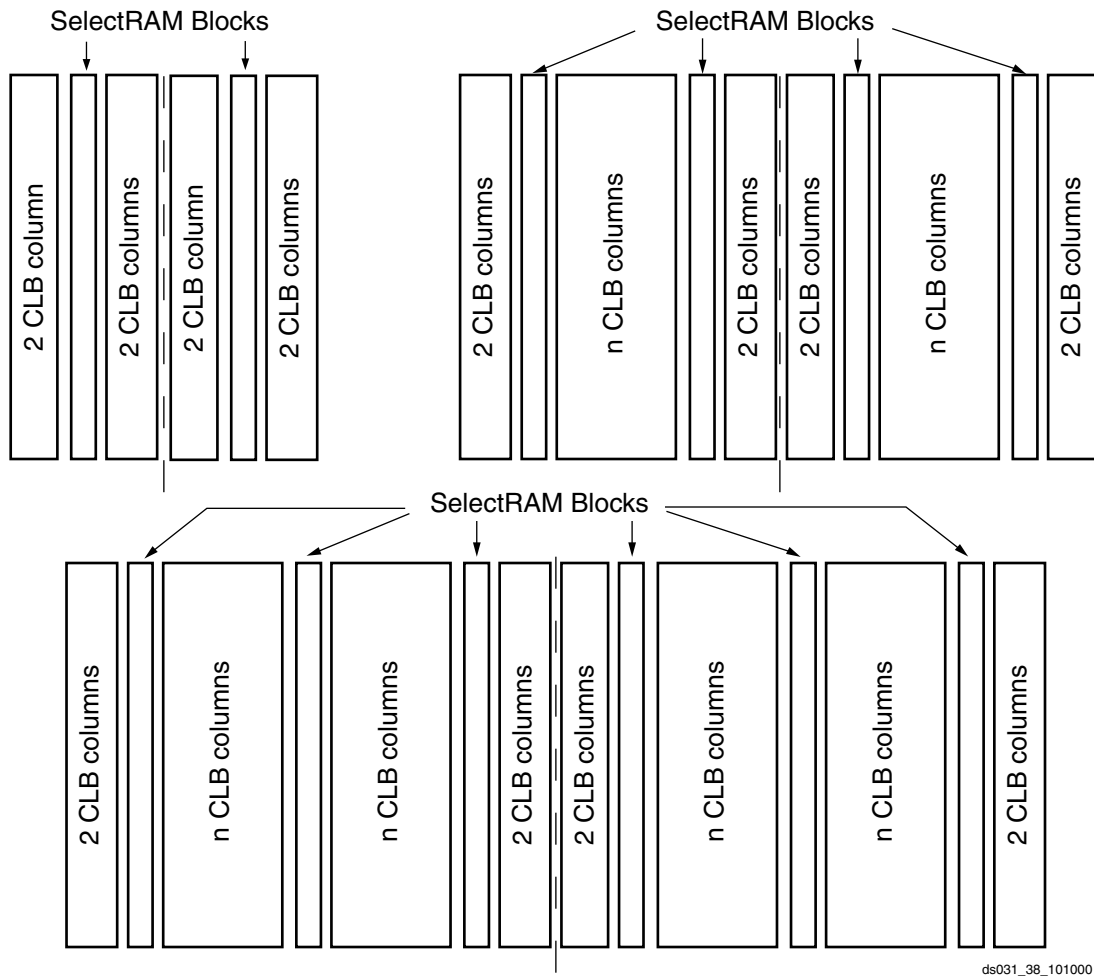


Figure 34: Block SelectRAM (2-column, 4-column, and 6-column)

Total Amount of SelectRAM Memory

Table 19 shows the amount of block SelectRAM memory available for each Virtex-II device. The 18 Kbit SelectRAM blocks are cascadable to implement deeper or wider single- or dual-port memory resources.

Table 19: Virtex-II SelectRAM Memory Available

Device	Total SelectRAM Memory		
	Blocks	in Kbits	in Bits
XC2V40	4	72	73,728
XC2V80	8	144	147,456
XC2V250	24	432	442,368
XC2V500	32	576	589,824
XC2V1000	40	720	737,280
XC2V1500	48	864	884,736
XC2V2000	56	1,008	1,032,192

Table 19: Virtex-II SelectRAM Memory Available

Device	Total SelectRAM Memory		
	Blocks	in Kbits	in Bits
XC2V3000	96	1,728	1,769,472
XC2V4000	120	2,160	2,211,840
XC2V6000	144	2,592	2,654,208
XC2V8000	168	3,024	3,096,576

18-Bit x 18-Bit Multipliers

Introduction

A Virtex-II multiplier block is an 18-bit by 18-bit 2's complement signed multiplier. Virtex-II devices incorporate many embedded multiplier blocks. These multipliers can be associated with an 18 Kbit block SelectRAM resource or can be used independently. They are optimized for high-speed operations and have a lower power consumption compared to an 18-bit x 18-bit multiplier in slices.

Table 17: IOB Output Switching Characteristics Standard Adjustments (Continued)

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
LVC MOS, 2.5V, Fast, 16 mA	LVC MOS25_F16	T _{OLVCMOS25_F16}	-0.18	-0.19	-0.21	ns
LVC MOS, 2.5V, Fast, 24 mA	LVC MOS25_F24	T _{OLVCMOS25_F24}	-0.35	-0.36	-0.40	ns
LVC MOS, 1.8V, Slow, 2 mA	LVC MOS18_S2	T _{OLVCMOS18_S2}	15.62	16.10	17.71	ns
LVC MOS, 1.8V, Slow, 4 mA	LVC MOS18_S4	T _{OLVCMOS18_S4}	10.20	10.51	11.57	ns
LVC MOS, 1.8V, Slow, 6 mA	LVC MOS18_S6	T _{OLVCMOS18_S6}	7.52	7.75	8.53	ns
LVC MOS, 1.8V, Slow, 8 mA	LVC MOS18_S8	T _{OLVCMOS18_S8}	6.87	7.08	7.78	ns
LVC MOS, 1.8V, Slow, 12 mA	LVC MOS18_S12	T _{OLVCMOS18_S12}	5.54	5.71	6.28	ns
LVC MOS, 1.8V, Slow, 16 mA	LVC MOS18_S16	T _{OLVCMOS18_S16}	5.31	5.47	6.02	ns
LVC MOS, 1.8V, Fast, 2 mA	LVC MOS18_F2	T _{OLVCMOS18_F2}	5.55	5.72	6.30	ns
LVC MOS, 1.8V, Fast, 4 mA	LVC MOS18_F4	T _{OLVCMOS18_F4}	1.89	1.95	2.15	ns
LVC MOS, 1.8V, Fast, 6 mA	LVC MOS18_F6	T _{OLVCMOS18_F6}	0.83	0.85	0.94	ns
LVC MOS, 1.8V, Fast, 8 mA	LVC MOS18_F8	T _{OLVCMOS18_F8}	0.70	0.72	0.80	ns
LVC MOS, 1.8V, Fast, 12 mA	LVC MOS18_F12	T _{OLVCMOS18_F12}	0.26	0.27	0.30	ns
LVC MOS, 1.8V, Fast, 16 mA	LVC MOS18_F16	T _{OLVCMOS18_F16}	0.23	0.23	0.26	ns
LVC MOS, 1.5V, Slow, 2 mA	LVC MOS15_S2	T _{OLVCMOS15_S2}	18.96	19.55	21.50	ns
LVC MOS, 1.5V, Slow, 4 mA	LVC MOS15_S4	T _{OLVCMOS15_S4}	12.77	13.17	14.48	ns
LVC MOS, 1.5V, Slow, 6 mA	LVC MOS15_S6	T _{OLVCMOS15_S6}	12.05	12.42	13.66	ns
LVC MOS, 1.5V, Slow, 8 mA	LVC MOS15_S8	T _{OLVCMOS15_S8}	9.75	10.06	11.06	ns
LVC MOS, 1.5V, Slow, 12 mA	LVC MOS15_S12	T _{OLVCMOS15_S12}	9.04	9.32	10.25	ns
LVC MOS, 1.5V, Slow, 16 mA	LVC MOS15_S16	T _{OLVCMOS15_S16}	8.21	8.46	9.31	ns
LVC MOS, 1.5V, Fast, 2 mA	LVC MOS15_F2	T _{OLVCMOS15_F2}	5.09	5.25	5.78	ns
LVC MOS, 1.5V, Fast, 4 mA	LVC MOS15_F4	T _{OLVCMOS15_F4}	2.01	2.07	2.27	ns
LVC MOS, 1.5V, Fast, 6 mA	LVC MOS15_F6	T _{OLVCMOS15_F6}	1.46	1.51	1.66	ns
LVC MOS, 1.5V, Fast, 8 mA	LVC MOS15_F8	T _{OLVCMOS15_F8}	0.93	0.96	1.05	ns
LVC MOS, 1.5V, Fast, 12 mA	LVC MOS15_F12	T _{OLVCMOS15_F12}	0.74	0.77	0.84	ns
LVC MOS, 1.5V, Fast, 16 mA	LVC MOS15_F16	T _{OLVCMOS15_F16}	0.67	0.69	0.75	ns
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	T _{OLVDS_25}	-0.31	-0.32	-0.36	ns
LVDS, 3.3V	LVDS_33	T _{OLVDS_33}	-0.25	-0.26	-0.29	ns
LVDSEXT (LVDS Extended Mode), 2.5V	LVDSEXT_25	T _{OLVDSEXT_25}	-0.18	-0.19	-0.21	ns
LVDSEXT, 3.3V	LVDSEXT_33	T _{OLVDSEXT_33}	-0.17	-0.18	-0.19	ns
ULVDS (Ultra LVDS), 2.5V	ULVDS_25	T _{OLVDS_25}	-0.20	-0.21	-0.23	ns
BLVDS (Bus LVDS), 2.5V	BLVDS_25	T _{OBLVDS_25}	0.67	0.69	0.76	ns
LDT (HyperTransport), 2.5V	LDT_25	T _{OLDT_25}	-0.20	-0.21	-0.23	ns
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	T _{OLVPECL_33}	0.29	0.30	0.33	ns
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3	T _{OPCI33_3}	1.15	1.19	1.31	ns
PCI, 66 MHz, 3.3V	PCI66_3	T _{OPCI66_3}	-0.01	-0.01	-0.01	ns
PCI-X, 133 MHz, 3.3V	PCIX	T _{OPCIX}	-0.01	-0.01	-0.01	ns
GTL (Gunning Transceiver Logic)	GTL	T _{OGTL}	-0.31	-0.32	-0.36	ns
GTL Plus	GTL P	T _{OGTLP}	-0.17	-0.18	-0.20	ns
HSTL (High-Speed Transceiver Logic), Class I	HSTL_I	T _{OHSTL_I}	0.26	0.27	0.29	ns
HSTL, Class II	HSTL_II	T _{OHSTL_II}	-0.15	-0.16	-0.17	ns
HSTL, Class III	HSTL_III	T _{OHSTL_III}	-0.17	-0.17	-0.19	ns
HSTL, Class IV	HSTL_IV	T _{OHSTL_IV}	-0.40	-0.41	-0.45	ns
HSTL, Class I, 1.8V	HSTL_I_18	T _{OHSTL_I_18}	0.03	0.03	0.04	ns

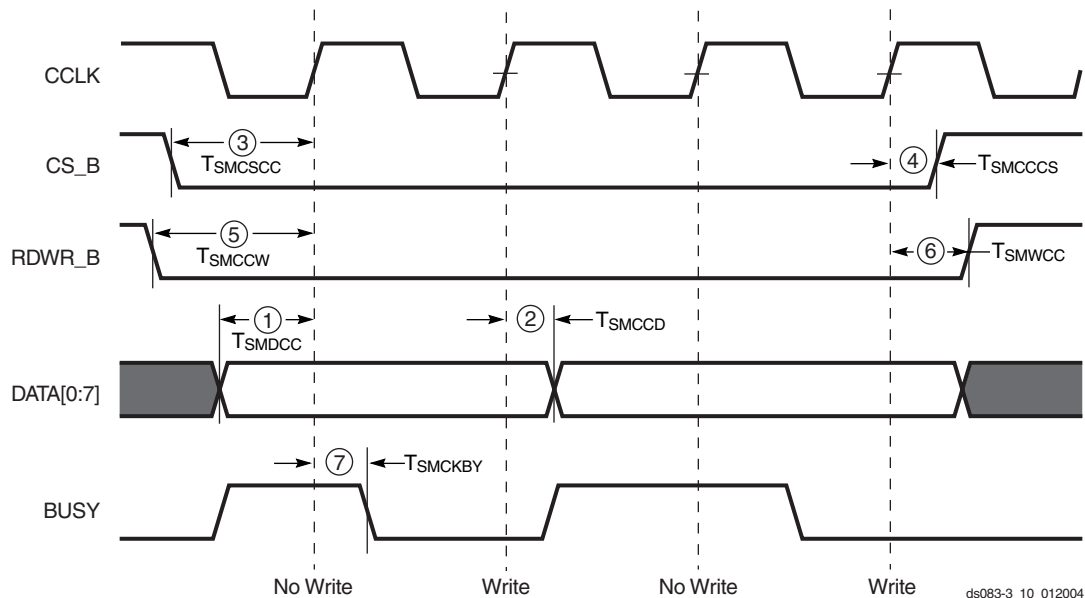


Figure 5: SelectMAP Mode Data Loading Sequence (Generic)

Table 32: SelectMAP Mode Write Timing Characteristics

	Description	Figure References	Symbol	Value	Units
CCLK	DATA[0:7] setup/hold	1/2	T_{SMDC}/T_{SMCCD}	5.0/0.0	ns, min
	CS_B setup/hold	3/4	T_{SMCSCC}/T_{SMCCCS}	7.0/0.0	ns, min
	RDWR_B setup/hold	5/6	T_{SMCCW}/T_{SMWCC}	7.0/0.0	ns, min
	BUSY propagation delay	7	T_{SMCKBY}	12.0	ns, max
	Maximum start-up frequency		$F_{CC_STARTUP}$	50	MHz, max
	Maximum frequency		$F_{CC_SELECTMAP}$	50	MHz, max
	Maximum frequency with no handshake		F_{CCNH}	50	MHz, max

Source Synchronous Timing Budgets

This section describes how to use the parameters provided in the [Source-Synchronous Switching Characteristics](#) section to develop system-specific timing budgets. The following analysis provides information necessary for determining Virtex-II contributions to an overall system timing analysis; no assumptions are made about the effects of Inter-Symbol Interference or PCB skew.

Virtex-II Transmitter Data-Valid Window (T_X)

T_X is the minimum aggregate valid data period for a source-synchronous data bus at the pins of the device and is calculated as follows:

$$T_X = \text{Data Period} - [\text{Jitter}^{(1)} + \text{Duty Cycle Distortion}^{(2)} + \text{TCKSKEW}^{(3)} + \text{TPKGSKEW}^{(4)}]$$

Notes:

1. Jitter values and accumulation methodology to be provided in a future release of this document. The absolute period jitter values found in the [DCM Timing Parameters](#) section of the particular DCM output clock used to clock the IOB FF can be used for a best case analysis.
2. This value depends on the clocking methodology used. See Note1 for [Table 45](#).
3. This value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA_Editor and Timing Analyzer tools to evaluate clock skew specific to your application.
4. These values represent the worst-case skew between any two balls of the package: shortest flight time to longest flight time from Pad to Ball.

Virtex-II Receiver Data-Valid Window (R_X)

R_X is the required minimum aggregate valid data period for a source-synchronous data bus at the pins of the device and is calculated as follows:

$$R_X = [\text{TSAMP}^{(1)} + \text{TCKSKEW}^{(2)} + \text{TPKGSKEW}^{(3)}]$$

Notes:

1. This parameter indicates the total sampling error of Virtex-II DDR input registers across voltage, temperature, and process. The characterization methodology uses the DCM to capture the DDR input registers' edges of operation. These measurements include:
 - CLK0 and CLK180 DCM jitter in a quiet system
 - Worst-case duty-cycle distortion
 - DCM accuracy (phase offset)
 - DCM phase shift resolution.
These measurements do not include package or clock tree skew.
2. This value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA_Editor and Timing Analyzer tools to evaluate clock skew specific to your application.
3. These values represent the worst-case skew between any two balls of the package: shortest flight time to longest flight time from Pad to Ball.

Revision History

This section records the change history for this module of the data sheet.

Date	Version	Revision
11/07/00	1.0	Early access draft.
12/06/00	1.1	Initial release.
01/15/01	1.2	Added values to the tables in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics sections.
01/25/01	1.3	• The data sheet was divided into four modules (per the current style standard). • Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables. • Table 18, "Delay Measurement Methodology"
04/23/01	1.5	• Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables. • Added T_{REG32} symbol to Table 23. • Skipped v1.4 to sync with other modules. Reverted to traditional double-column format.

Table 4: Virtex-II Pin Definitions (Continued)

Pin Name	Direction	Description
PROG_B	Input	Active Low asynchronous reset to configuration logic. This pin has a permanent weak pull-up resistor.
DONE	Input/Output	DONE is a bidirectional signal with an optional internal pull-up resistor. As an output, this pin indicates completion of the configuration process. As an input, a Low level on DONE can be configured to delay the start-up sequence.
M2, M1, M0	Input	Configuration mode selection.
HSWAP_EN	Input	Enable I/O pull-ups during configuration.
TCK	Input	Boundary Scan Clock.
TDI	Input	Boundary Scan Data Input.
TDO	Output	Boundary Scan Data Output.
TMS	Input	Boundary Scan Mode Select.
PWRDWN_B	Input (unsupported)	Active Low power-down pin (unsupported). <i>Driving this pin Low can adversely affect device operation and configuration.</i> PWRDWN_B is internally pulled High, which is its default state. It does not require an external pull-up.
Other Pins		
DXN, DXP	N/A	Temperature-sensing diode pins (Anode: DXP, Cathode: DXN).
V _{BATT}	Input	Decryptor key memory backup supply. Connect V _{BATT} to V _{CCAUX} or GND if battery is not used.
RSVD	N/A	Reserved pin - do not connect.
V _{CCO}	Input	Power-supply pins for the output drivers (per bank).
V _{CCAUX}	Input	Power-supply pins for auxiliary circuits.
V _{CCINT}	Input	Power-supply pins for the internal core logic.
GND	Input	Ground.

Notes:

1. All dedicated pins (JTAG and configuration) are powered by V_{CCAUX} (independent of the bank V_{CCO} voltage).

Table 5: CS144/CSG144 — XC2V40, XC2V80, and XC2V250

Bank	Pin Description	Pin Number	No Connect in the XC2V40
2	IO_L96N_2	G11	
2	IO_L96P_2	G13	
3	IO_L96N_3	G12	
3	IO_L96P_3	H12	
3	IO_L94N_3	H11	
3	IO_L94P_3	J13	
3	IO_L03N_3/VREF_3	J10	
3	IO_L03P_3	K13	
3	IO_L02N_3/VRP_3	K12	
3	IO_L02P_3/VRN_3	K11	
3	IO_L01N_3	K10	
3	IO_L01P_3	L13	
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	M11	
4	IO_L01P_4/INIT_B	N11	
4	IO_L02N_4/D0/DIN ⁽¹⁾	L10	
4	IO_L02P_4/D1	M10	
4	IO_L03N_4/D2/ALT_VRP_4	N10	
4	IO_L03P_4/D3/ALT_VRN_4	K9	
4	IO_L94N_4/VREF_4	N9	
4	IO_L94P_4	K8	
4	IO_L95N_4/GCLK3S	L8	
4	IO_L95P_4/GCLK2P	M8	
4	IO_L96N_4/GCLK1S	N8	
4	IO_L96P_4/GCLK0P	K7	
5	IO_L96N_5/GCLK7S	N7	
5	IO_L96P_5/GCLK6P	M7	
5	IO_L95N_5/GCLK5S	N6	
5	IO_L95P_5/GCLK4P	M6	
5	IO_L94N_5	L6	
5	IO_L94P_5/VREF_5	K6	
5	IO_L03N_5/D4/ALT_VRP_5	L5	
5	IO_L03P_5/D5/ALT_VRN_5	K5	
5	IO_L02N_5/D6	N4	
5	IO_L02P_5/D7	M4	
5	IO_L01N_5/RDWR_B	L4	
5	IO_L01P_5/CS_B	K4	

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
3	IO_L46P_3	Y26		
3	IO_L45N_3/VREF_3	U20		
3	IO_L45P_3	V20		
3	IO_L43N_3	W25		
3	IO_L43P_3	W24		
3	IO_L25N_3	V21	NC	NC
3	IO_L25P_3	W21	NC	NC
3	IO_L24N_3	AA26		
3	IO_L24P_3	AA25		
3	IO_L22N_3	Y24		
3	IO_L22P_3	Y23		
3	IO_L21N_3/VREF_3	W22		
3	IO_L21P_3	W23		
3	IO_L19N_3	AB26		
3	IO_L19P_3	AB25		
3	IO_L06N_3	AC26		
3	IO_L06P_3	AC25		
3	IO_L04N_3	AD26		
3	IO_L04P_3	AD25		
3	IO_L03N_3/VREF_3	AA24		
3	IO_L03P_3	AA23		
3	IO_L02N_3/VRP_3	AB24		
3	IO_L02P_3/VRN_3	AB23		
3	IO_L01N_3	Y22		
3	IO_L01P_3	AA22		
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	AD21		
4	IO_L01P_4/INIT_B	AC21		
4	IO_L02N_4/D0/DIN ⁽¹⁾	Y20		
4	IO_L02P_4/D1	Y19		
4	IO_L03N_4/D2/ALT_VRP_4	AA20		
4	IO_L03P_4/D3/ALT_VRN_4	AB20		
4	IO_L04N_4/VREF_4	AC22		
4	IO_L04P_4	AE21		
4	IO_L05N_4/VRP_4	AE26		
4	IO_L05P_4/VRN_4	AF25		
4	IO_L06N_4	W20		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
5	IO_L02P_5/D7	AC6		
5	IO_L01N_5/RDWR_B	AB6		
5	IO_L01P_5/CS_B	AC5		
6	IO_L01P_6	AF2		
6	IO_L01N_6	AE1		
6	IO_L02P_6/VRN_6	AB4		
6	IO_L02N_6/VRP_6	AB3		
6	IO_L03P_6	AD2		
6	IO_L03N_6/VREF_6	AD1		
6	IO_L04P_6	AC2		
6	IO_L04N_6	AC1		
6	IO_L06P_6	AB2		
6	IO_L06N_6	AB1		
6	IO_L19P_6	AA4		
6	IO_L19N_6	AA3		
6	IO_L21P_6	Y6		
6	IO_L21N_6/VREF_6	Y5		
6	IO_L22P_6	W6		
6	IO_L22N_6	W7		
6	IO_L24P_6	AA2		
6	IO_L24N_6	AA1		
6	IO_L25P_6	Y4	NC	NC
6	IO_L25N_6	Y3	NC	NC
6	IO_L43P_6	W5		
6	IO_L43N_6	W4		
6	IO_L45P_6	W2		
6	IO_L45N_6/VREF_6	W3		
6	IO_L46P_6	Y1		
6	IO_L46N_6	W1		
6	IO_L48P_6	V6		
6	IO_L48N_6	V7		
6	IO_L49P_6	V5		
6	IO_L49N_6	V4		
6	IO_L51P_6	V3		
6	IO_L51N_6/VREF_6	V2		
6	IO_L52P_6	V1		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
7	IO_L78N_7	M2	NC	
7	IO_L76P_7	M5	NC	
7	IO_L76N_7	M6	NC	
7	IO_L75P_7/VREF_7	M3	NC	
7	IO_L75N_7	M4	NC	
7	IO_L73P_7	M7	NC	
7	IO_L73N_7	M8	NC	
7	IO_L72P_7	L1		
7	IO_L72N_7	L2		
7	IO_L70P_7	L5		
7	IO_L70N_7	L6		
7	IO_L69P_7/VREF_7	L3		
7	IO_L69N_7	L4		
7	IO_L67P_7	K1		
7	IO_L67N_7	J1		
7	IO_L54P_7	K3		
7	IO_L54N_7	K4		
7	IO_L52P_7	K5		
7	IO_L52N_7	K6		
7	IO_L51P_7/VREF_7	L8		
7	IO_L51N_7	L7		
7	IO_L49P_7	J2		
7	IO_L49N_7	H1		
7	IO_L48P_7	J3		
7	IO_L48N_7	J4		
7	IO_L46P_7	J5		
7	IO_L46N_7	J6		
7	IO_L45P_7/VREF_7	H5		
7	IO_L45N_7	H4		
7	IO_L43P_7	K7		
7	IO_L43N_7	J7		
7	IO_L25P_7	H2	NC	NC
7	IO_L25N_7	H3	NC	NC
7	IO_L24P_7	G1		
7	IO_L24N_7	F1		
7	IO_L22P_7	G3		
7	IO_L22N_7	G4		

BG575/BGG575 Standard BGA Package

As shown in Table 9, XC2V1000, XC2V1500, and XC2V2000 Virtex-II devices are available in the BG575/BGG575 BGA package. Pins in the XC2V1000, XC2V1500, and XC2V2000 devices are the same, except for the pin differences in the XC2V1000 and XC2V1500 devices shown in the No Connect columns. Following this table are the **BG575/BGG575 Standard BGA Package Specifications (1.27mm pitch)**.

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
0	IO_L01N_0	A3		
0	IO_L01P_0	A4		
0	IO_L02N_0	D5		
0	IO_L02P_0	C5		
0	IO_L03N_0/VRP_0	E6		
0	IO_L03P_0/VRN_0	D6		
0	IO_L04N_0/VREF_0	F7		
0	IO_L04P_0	E7		
0	IO_L05N_0	G8		
0	IO_L05P_0	H9		
0	IO_L06N_0	A5		
0	IO_L06P_0	A6		
0	IO_L19N_0	B5		
0	IO_L19P_0	B6		
0	IO_L21N_0	D7		
0	IO_L21P_0/VREF_0	C7		
0	IO_L22N_0	F8		
0	IO_L22P_0	E8		
0	IO_L24N_0	G9		
0	IO_L24P_0	F9		
0	IO_L49N_0	G10		
0	IO_L49P_0	H10		
0	IO_L51N_0	B7		
0	IO_L51P_0/VREF_0	B8		
0	IO_L52N_0	D8		
0	IO_L52P_0	C8		
0	IO_L54N_0	E9		
0	IO_L54P_0	D9		
0	IO_L67N_0	A8	NC	
0	IO_L67P_0	A9	NC	
0	IO_L69N_0	C9	NC	

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
2	IO_L01P_2	D23		
2	IO_L02N_2/VRP_2	E21		
2	IO_L02P_2/VRN_2	E22		
2	IO_L03N_2	F21		
2	IO_L03P_2/VREF_2	F20		
2	IO_L04N_2	G20		
2	IO_L04P_2	G19		
2	IO_L06N_2	H18		
2	IO_L06P_2	J17		
2	IO_L19N_2	D24		
2	IO_L19P_2	E23		
2	IO_L21N_2	E24		
2	IO_L21P_2/VREF_2	F24		
2	IO_L22N_2	F23		
2	IO_L22P_2	G23		
2	IO_L24N_2	G21		
2	IO_L24P_2	G22		
2	IO_L43N_2	H19		
2	IO_L43P_2	H20		
2	IO_L45N_2	J18		
2	IO_L45P_2/VREF_2	J19		
2	IO_L46N_2	K17		
2	IO_L46P_2	K18		
2	IO_L48N_2	H23		
2	IO_L48P_2	H24		
2	IO_L49N_2	H21		
2	IO_L49P_2	H22		
2	IO_L51N_2	J24		
2	IO_L51P_2/VREF_2	K24		
2	IO_L52N_2	J22		
2	IO_L52P_2	J23		
2	IO_L54N_2	J20		
2	IO_L54P_2	J21		
2	IO_L67N_2	K19	NC	
2	IO_L67P_2	K20	NC	
2	IO_L69N_2	L17	NC	

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
5	IO_L52N_5	AC10
5	IO_L52P_5	AB10
5	IO_L51N_5/VREF_5	Y9
5	IO_L51P_5	Y10
5	IO_L49N_5	AG9
5	IO_L49P_5	AG8
5	IO_L30N_5	AF9
5	IO_L30P_5	AE9
5	IO_L28N_5	AD9
5	IO_L28P_5	AC9
5	IO_L27N_5/VREF_5	AB9
5	IO_L27P_5	AA9
5	IO_L25N_5	AE8
5	IO_L25P_5	AE7
5	IO_L24N_5	AD8
5	IO_L24P_5	AC8
5	IO_L22N_5	AB8
5	IO_L22P_5	AA8
5	IO_L21N_5/VREF_5	AG7
5	IO_L21P_5	AF7
5	IO_L19N_5	AC7
5	IO_L19P_5	AB7
5	IO_L06N_5	AG6
5	IO_L06P_5	AF6
5	IO_L05N_5/VRP_5	AE6
5	IO_L05P_5/VRN_5	AD6
5	IO_L04N_5	AG5
5	IO_L04P_5/VREF_5	AF5
5	IO_L03N_5/D4/ALT_VRP_5	AE5
5	IO_L03P_5/D5/ALT_VRN_5	AD5
5	IO_L02N_5/D6	AG4
5	IO_L02P_5/D7	AF4
5	IO_L01N_5/RDWR_B	AG3
5	IO_L01P_5/CS_B	AF3
6	IO_L01P_6	AE1

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
6	IO_L01N_6	AD1
6	IO_L02P_6/VRN_6	AD3
6	IO_L02N_6/VRP_6	AD2
6	IO_L03P_6	AC4
6	IO_L03N_6/VREF_6	AC3
6	IO_L04P_6	AC2
6	IO_L04N_6	AC1
6	IO_L06P_6	AB5
6	IO_L06N_6	AB4
6	IO_L19P_6	AB3
6	IO_L19N_6	AB2
6	IO_L21P_6	AB1
6	IO_L21N_6/VREF_6	AA1
6	IO_L22P_6	AA5
6	IO_L22N_6	AA6
6	IO_L24P_6	AA3
6	IO_L24N_6	AA2
6	IO_L25P_6	Y5
6	IO_L25N_6	Y6
6	IO_L27P_6	Y4
6	IO_L27N_6/VREF_6	Y3
6	IO_L28P_6	Y1
6	IO_L28N_6	W1
6	IO_L43P_6	W8
6	IO_L43N_6	W9
6	IO_L45P_6	W6
6	IO_L45N_6/VREF_6	W7
6	IO_L46P_6	W5
6	IO_L46N_6	W4
6	IO_L48P_6	W3
6	IO_L48N_6	W2
6	IO_L49P_6	V7
6	IO_L49N_6	V8
6	IO_L51P_6	V5
6	IO_L51N_6/VREF_6	V6
6	IO_L52P_6	V4

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
3	IO_L24N_3	AC8		
3	IO_L24P_3	AB8		
3	IO_L23N_3	AE2		
3	IO_L23P_3	AF3		
3	IO_L22N_3	AD3		
3	IO_L22P_3	AE3		
3	IO_L21N_3/VREF_3	AD6		
3	IO_L21P_3	AD7		
3	IO_L20N_3	AF1		
3	IO_L20P_3	AG1		
3	IO_L19N_3	AD4		
3	IO_L19P_3	AE4		
3	IO_L06N_3	AD8		
3	IO_L06P_3	AE7		
3	IO_L05N_3	AG2		
3	IO_L05P_3	AH2		
3	IO_L04N_3	AD5		
3	IO_L04P_3	AE5		
3	IO_L03N_3/VREF_3	AC9		
3	IO_L03P_3	AD9		
3	IO_L02N_3/VRP_3	AH1		
3	IO_L02P_3/VRN_3	AJ1		
3	IO_L01N_3	AF4		
3	IO_L01P_3	AG3		
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	AK2		
4	IO_L01P_4/INIT_B	AJ3		
4	IO_L02N_4/D0/DIN ⁽¹⁾	AE8		
4	IO_L02P_4/D1	AF9		
4	IO_L03N_4/D2/ALT_VRP_4	AH5		
4	IO_L03P_4/D3/ALT_VRN_4	AH6		
4	IO_L04N_4/VREF_4	AJ4		
4	IO_L04P_4	AK4		
4	IO_L05N_4/VRP_4	AC10		
4	IO_L05P_4/VRN_4	AC11		
4	IO_L06N_4	AH7		
4	IO_L06P_4	AG6		

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
6	IO_L71P_6	AD34	
6	IO_L71N_6	AC34	
6	IO_L72P_6	AC31	
6	IO_L72N_6	AD31	
6	IO_L73P_6	Y27	
6	IO_L73N_6	W27	
6	IO_L74P_6	AB29	
6	IO_L74N_6	AA29	
6	IO_L75P_6	AB31	
6	IO_L75N_6/VREF_6	AA31	
6	IO_L76P_6	Y28	
6	IO_L76N_6	Y29	
6	IO_L77P_6	AB33	
6	IO_L77N_6	AA33	
6	IO_L78P_6	AA30	
6	IO_L78N_6	AB30	
6	IO_L79P_6	W24	NC
6	IO_L79N_6	V24	NC
6	IO_L80P_6	AB34	NC
6	IO_L80N_6	AA34	NC
6	IO_L81P_6	W33	NC
6	IO_L81N_6/VREF_6	Y34	NC
6	IO_L82P_6	W25	NC
6	IO_L82N_6	V25	NC
6	IO_L83P_6	Y32	NC
6	IO_L83N_6	AA32	NC
6	IO_L84P_6	W29	NC
6	IO_L84N_6	V29	NC
6	IO_L91P_6	W28	
6	IO_L91N_6	V28	
6	IO_L92P_6	V33	
6	IO_L92N_6	V34	
6	IO_L93P_6	Y31	
6	IO_L93N_6/VREF_6	W31	
6	IO_L94P_6	V26	
6	IO_L94N_6	V27	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L69N_1/VREF_1	E15		
1	IO_L69P_1	E16		
1	IO_L68N_1	K17		
1	IO_L68P_1	K16		
1	IO_L67N_1	C15		
1	IO_L67P_1	B15		
1	IO_L60N_1	F15		
1	IO_L60P_1	F16		
1	IO_L59N_1	H16		
1	IO_L59P_1	H15		
1	IO_L58N_1	C13		
1	IO_L58P_1	C14		
1	IO_L57N_1/VREF_1	D13		
1	IO_L57P_1	D14		
1	IO_L56N_1	M17		
1	IO_L56P_1	M16		
1	IO_L55N_1	A12		
1	IO_L55P_1	A13		
1	IO_L54N_1	B12		
1	IO_L54P_1	B13		
1	IO_L53N_1	G15		
1	IO_L53P_1	G14		
1	IO_L52N_1	C11		
1	IO_L52P_1	C12		
1	IO_L51N_1/VREF_1	F13		
1	IO_L51P_1	F14		
1	IO_L50N_1	L16		
1	IO_L50P_1	L15		
1	IO_L49N_1	A10		
1	IO_L49P_1	A11		
1	IO_L36N_1	E12	NC	
1	IO_L36P_1	E13	NC	
1	IO_L35N_1	K15	NC	
1	IO_L35P_1	J14	NC	
1	IO_L34N_1	B9	NC	
1	IO_L34P_1	B10	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L09N_1/VREF_1	G9	NC	
1	IO_L09P_1	G10	NC	
1	IO_L08N_1	K13	NC	
1	IO_L08P_1	K12	NC	
1	IO_L07N_1	A4	NC	
1	IO_L07P_1	A5	NC	
1	IO_L06N_1	F8		
1	IO_L06P_1	E8		
1	IO_L05N_1	J11		
1	IO_L05P_1	K11		
1	IO_L04N_1	C5		
1	IO_L04P_1/VREF_1	C6		
1	IO_L03N_1/VRP_1	D6		
1	IO_L03P_1/VRN_1	D7		
1	IO_L02N_1	H10		
1	IO_L02P_1	J10		
1	IO_L01N_1	C4		
1	IO_L01P_1	B4		
2	IO_L01N_2	E3		
2	IO_L01P_2	D2		
2	IO_L02N_2/VRP_2	L13		
2	IO_L02P_2/VRN_2	M13		
2	IO_L03N_2	F4		
2	IO_L03P_2/VREF_2	E4		
2	IO_L04N_2	E1		
2	IO_L04P_2	D1		
2	IO_L05N_2	L12		
2	IO_L05P_2	M11		
2	IO_L06N_2	G6		
2	IO_L06P_2	F5		
2	IO_L07N_2	F2	NC	
2	IO_L07P_2	E2	NC	
2	IO_L08N_2	M12	NC	
2	IO_L08P_2	N12	NC	
2	IO_L09N_2	H6	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	VCCO_1	E11		
1	VCCO_1	C18		
1	VCCO_1	B14		
2	VCCO_2	W14		
2	VCCO_2	W13		
2	VCCO_2	V14		
2	VCCO_2	V13		
2	VCCO_2	V3		
2	VCCO_2	U14		
2	VCCO_2	U13		
2	VCCO_2	U11		
2	VCCO_2	T14		
2	VCCO_2	T13		
2	VCCO_2	R14		
2	VCCO_2	R13		
2	VCCO_2	R9		
2	VCCO_2	P13		
2	VCCO_2	P2		
2	VCCO_2	N7		
2	VCCO_2	L5		
3	VCCO_3	AJ5		
3	VCCO_3	AG7		
3	VCCO_3	AF13		
3	VCCO_3	AF2		
3	VCCO_3	AE14		
3	VCCO_3	AE13		
3	VCCO_3	AE9		
3	VCCO_3	AD14		
3	VCCO_3	AD13		
3	VCCO_3	AC14		
3	VCCO_3	AC13		
3	VCCO_3	AC11		
3	VCCO_3	AB14		
3	VCCO_3	AB13		
3	VCCO_3	AB3		
3	VCCO_3	AA14		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	GND	AC20		
NA	GND	AC19		
NA	GND	AC18		
NA	GND	AC17		
NA	GND	AC16		
NA	GND	AC8		
NA	GND	AC4		
NA	GND	AB24		
NA	GND	AB23		
NA	GND	AB22		
NA	GND	AB21		
NA	GND	AB20		
NA	GND	AB19		
NA	GND	AB18		
NA	GND	AB17		
NA	GND	AB16		
NA	GND	AA24		
NA	GND	AA23		
NA	GND	AA22		
NA	GND	AA21		
NA	GND	AA20		
NA	GND	AA19		
NA	GND	AA18		
NA	GND	AA17		
NA	GND	AA16		
NA	GND	Y39		
NA	GND	Y36		
NA	GND	Y33		
NA	GND	Y30		
NA	GND	Y24		
NA	GND	Y23		
NA	GND	Y22		
NA	GND	Y21		
NA	GND	Y20		
NA	GND	Y19		
NA	GND	Y18		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	GND	Y17		
NA	GND	Y16		
NA	GND	Y10		
NA	GND	Y7		
NA	GND	Y4		
NA	GND	Y1		
NA	GND	W24		
NA	GND	W23		
NA	GND	W22		
NA	GND	W21		
NA	GND	W20		
NA	GND	W19		
NA	GND	W18		
NA	GND	W17		
NA	GND	W16		
NA	GND	V24		
NA	GND	V23		
NA	GND	V22		
NA	GND	V21		
NA	GND	V20		
NA	GND	V19		
NA	GND	V18		
NA	GND	V17		
NA	GND	V16		
NA	GND	U36		
NA	GND	U32		
NA	GND	U24		
NA	GND	U23		
NA	GND	U22		
NA	GND	U21		
NA	GND	U20		
NA	GND	U19		
NA	GND	U18		
NA	GND	U17		
NA	GND	U16		
NA	GND	U8		